

## **Application Data Sheet**

### **Application Information**

<b>Filing Date::</b>	1/21/04
<b>Application Type::</b>	Regular
<b>Subject Matter::</b>	Utility
<b>CD-ROM or CD-R?</b>	None
<b>Title::</b>	Through-wafer Contact to Bonding Pad
<b>Attorney Docket Number::</b>	JMH-P001
<b>Request for Early Publication?::</b>	No
<b>Request for Non-Publication?::</b>	No
<b>Suggested Drawing Figures::</b>	6
<b>Total Drawing Sheets::</b>	6
<b>Small Entity::</b>	Yes
<b>Petition included?::</b>	No
<b>Secrecy Order in Parent Appl.?::</b>	No

### **Applicant Information**

<b>Applicant Authority type::</b>	Inventor
<b>Primary Citizenship Country::</b>	United States
<b>Status::</b>	Full Capacity
<b>Given Name::</b>	James M.
<b>Family Name::</b>	Harris

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**State or Province of Residence::** CA  
**Country of Residence::** U.S.A.  
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## **Correspondence Information**

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